

Features

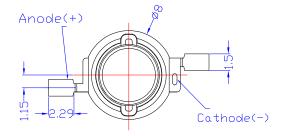
- Highest Luminous Flux
- Super Energy Efficiency ٠
- Long Lifetime Operation
- Superior UV Resistance ٠

Applications

- Read lights (car, bus, aircraft)
- Portable (flashlight, bicycle) •
- Bollards / Security / Garden •
- Traffic signaling / Beacons ٠
- In door / Out door Commercial lights •
- Automotive Ext

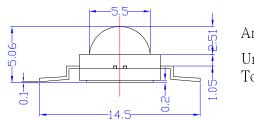
■Absolute Maximum Rating

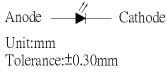
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Item	Symbol	Value	Unit
DC Forward Current	$I_{\rm F}$	400	mA
Pulse Forward Current*	$I_{\rm FP}$	500	mA
Reverse Voltage	V _R	5	v
Power Dissipation	P _D	1200	mW
Operating Temperature	Topr	-30 ~ +85	°C
Storage Temperature	Tstg	-40~ +100	°C
Lead Soldering Temperature	Tsol	260°C /5sec	-



•Outline Dimension

(Ta=25°C)





Directivity

400 350

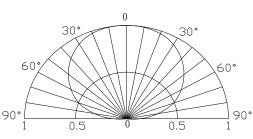
300 250 200

150

100

50 0 0

Forward Current, IF (mA)



■Forward Operating Current (DC)

/W /W /W RI-A=60 RJ-A=50

RJ-A=40

B.I-A=30 /W

40

Ambient Temperature, TA (

*Pulse width Max.10ms Duty ratio max 1/10

Electrical -Optical Characteristics

Electrical -Optical Characteristics			(Ta=25℃)			
Item	Symbol	Condition	Min.	Тур.	Max.	Unit
DC Forward Voltage	$V_{\rm F}$	I _F =350mA	2.0	2.5	3.0	V
DC Reverse Current	I _R	V _R =5V	-	-	10	μA
Domi. Wavelength	λ_{D}	I _F =350mA	585	590	595	nm
Luminous Flux	Φv	I _F =350mA	40	50	-	lm
50% Power Angle	2 0 1/2	I _F =350mA	-	140	-	deg

Note: Don't drive at rated current more than 5s without heat sink for Xeon 1 emitter series.

LED & Application Technologies







20



60

80



100



Xeon 1 Power Yellow LED

OSY5XNE1E1E

<u>VER C.2</u>

■ Soldering Heat Reliability :

- Reflow soldering Profile
- \cdot Reflow soldering should not be done more than two times.
- \cdot When soldering, do not put stress on the LEDs during heating.
- \cdot After soldering, do not warp the circuit board.
- \cdot Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable,
- a double-head soldering iron should be used. It should be confirmed beforehand whether the

characteristics of the LEDs will or will not be damaged by repairing.

Solder			
Average ramp-up rate = 3°C/sec. max.			
Preheat temperature: 150°~180°C			
Preheat time = 120 sec. max.			
Ramp-down rate = 6° C/sec. max.			
Peak temperature = 220° C max.			
Time within 3°C of actual			
peak temperature = 25 sec. max.			
Duration above 200°C is 40 sec. max.			

